

LMH0026 SD SDI Reclocker with Dual Differential Outputs

Check for Samples: LMH0026

FEATURES

- Supports SMPTE 259M (C) Serial Digital Video Standard
- Supports 270 Mbps Serial Data Rate Operation
- Supports DVB-ASI at 270 Mbps
- Single 3.3V Supply Operation
- 330 mW Typical Power Consumption
- **Two Differential, Reclocked Outputs** .
- Choice of Second Reclocked Output or Low-Jitter, Differential, Data-Rate Clock Output
- Single 27 MHz External Crystal or Reference Clock Input
- Lock Detect Indicator Output
- **Output Mute Function for Data and Clock**
- Auto/Manual Reclocker Bypass
- Differential LVPECL Compatible Serial Data • Inputs and Outputs
- **LVCMOS Control Inputs and Indicator Outputs** •
- 20-Pin HTSSOP Package
- Industrial Temperature Range: -40°C to +85°C
- Footprint Compatible with the LMH0046 and LMH0346

APPLICATIONS

- SDTV Serial Digital Video Interfaces for:
 - Digital Video Routers and Switchers
 - Digital Video Processing and Editing Equipment
 - DVB-ASI Equipment
 - Video Standards and Format Converters

DESCRIPTION

The LMH0026 SD SDI Reclocker retimes serial digital video data conforming to the SMPTE 259M (C) standard. The LMH0026 operates at the serial data rate of 270 Mbps and also supports DVB-ASI operation at 270 Mbps.

The LMH0026 retimes the incoming data to suppress accumulated jitter. The LMH0026 recovers the serial data-rate clock and optionally provides it as an output. The LMH0026 has two differential serial data outputs; the second output may be selected as a lowjitter, data-rate clock output. Controls and indicators are: serial clock or second serial data output select, SD indicator output, lock detect output, auto/manual data bypass, and output mute. The serial data inputs, outputs, and serial data-rate clock outputs are differential LVPECL compatible. The CML serial data and serial data-rate clock outputs are suitable for driving 100Ω differentially terminated networks. The control logic inputs and outputs are LVCMOS compatible.

The LMH0026 is powered from a single 3.3V supply. Power dissipation is typically 330 mW. The device is housed in a 20-pin HTSSOP package.

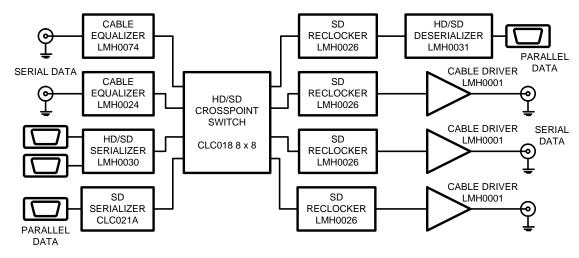


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. All trademarks are the property of their respective owners.

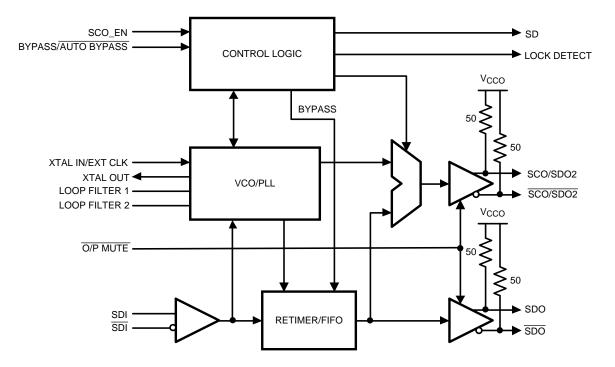


www.ti.com

TYPICAL APPLICATION



Block Diagram



2



SNLS253A - MARCH 2008 - REVISED OCTOBER 2009

CONNECTION DIAGRAM

2 LF1 SCO_EN 19 3 NC Vcco 18 4 RSVD SDO 16 5 SDI LMH0026 SDO 15 7 Vcc SCO/SDO2 13 9 OP MUTE LOCK DET 11 10 XTAL IN/EXT CLK XTAL OUT 11	SD 18 V _{CCO} 17 SDO 16 SDO 15 SCO/SDO2 14 SCO/SDO2 12 LOCK DET 11	2 LF2 SD 3 NC Vcco 4 RSVD SDO 5 SDI LMH0026 Vcco 7 Vcc SCO/SDO2 8 9 OP MUTE LOCK DET 10
--	---	---

The exposed die attach pad is the negative electrical terminal for this device. It must be connected to the negative power supply voltage.

Figure 1. 20-Pin HTSSOP

Pin	Name	Description
1	LF1	Loop Filter.
2	LF2	Loop Filter.
3	NC	No Connect. Not bonded internally.
4	RSVD	Reserved. Do not connect or connect to ground.
5	SDI	Data Input true.
6	SDI	Data Input complement.
7	V _{CC}	Positive power supply input.
8	BYPASS/AUTO BYPASS	Bypass/Auto Bypass mode select. Bypasses reclocking when high. This pin has an internal pulldown.
9	OUTPUT MUTE	Data and Clock Output Mute input. Mutes the output when low. This pin has an internal pullup.
10	XTAL IN/EXT CLK	Crystal or External Oscillator input.
11	XTAL OUT	Crystal Oscillator output.
12	LOCK DETECT	PLL Lock Detect output (active high).
13	SCO/SDO2	Serial Clock or Serial Data Output 2 complement.
14	SCO/SDO2	Serial Clock or Serial Data Output 2 true.
15	V _{CCO}	Positive power supply input (Output Driver).
16	SDO	Data Output complement.
17	SDO	Data Output true.
18	V _{CCO}	Positive power supply input (output driver).
19	SD	SD indicator output. Output is high when locked to 270 Mbps.
20	SCO_EN	Serial Clock or Serial Data 2 Output select. Sets second output to output the clock when high and the data when low. This pin has an internal pulldown.
DAP	V _{EE}	Connect exposed DAP to negative power supply (ground).

PIN DESCRIPTIONS

LMH0026

SNLS253A-MARCH 2008-REVISED OCTOBER 2009

www.ti.com

RUMENTS

(AS



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS (1)(2)

Supply Voltage (V _{CC} –V _{EE})	4.0V	
Logic Supply Voltage (Vi)		V _{EE} =0.15V to V _{CC} +0.15V
Logic Input Current (single input):	Vi = V _{EE} -0.15V	-5 mA
	$Vi = V_{CC} + 0.15V$	+5 mA
Logic Output Voltage (Vo)	V _{EE} -0.15V to V _{CC} +0.15V	
Logic Output Source/Sink Current	±8 mA	
Serial Data Input Voltage (V _{SDI})	V_{CC} to V_{CC} -2.0V	
Serial Data Output Sink Current (I _{SDO})	24 mA	
Package Thermal Resistance, HTSSOP	θ _{JA}	26.6°C/W
	θ _{JC}	2.4°C/W
Storage Temp. Range		−65°C to +150°C
Junction Temperature		+150°C
Lead Temperature (Soldering 4 Sec)		+260°C (Pb-free)
ESD Rating (HBM)		7 kV
ESD Rating (MM)		350V
ESD Rating (CDM)		1250V

"Absolute Maximum Ratings" are those parameter values beyond which the life and operation of the device cannot be ensured. The stating herein of these maximums shall not be construed to imply that the device can or should be operated at or beyond these values. DC ELECTRICAL CHARACTERISTICS and AC ELECTRICAL CHARACTERISTICS specify acceptable device operating conditions.
(2) It is anticipated that this device will not be efforted in a military qualified version. If Military/Acceptable devices are

(2) It is anticipated that this device will not be offered in a military qualified version. If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

RECOMMENDED OPERATING CONDITIONS

Supply Voltage (V _{CC} –V _{EE})		3.3V ±5%
Logic Input Voltage	V_{EE} to V_{CC}	
Differential Serial Input Voltage	800 mV ±10%	
Serial Data or Clock Output Sink	Current (I _{SO})	16 mA max.
Operating Free Air Temperature (T _A)		-40°C to +85°C

DC ELECTRICAL CHARACTERISTICS

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified. (1)(2)

Symbol	Parameter	Conditions	Reference	Min	Тур	Max	Units
V _{IH}	Input Voltage High Level		Logic level inputs	2		V _{CC}	V
VIL	Input Voltage Low Level			V _{EE}		0.8	V
I _{IH}	Input Current High Level	$V_{IH} = V_{CC}$			47	65	μA
۱ _{IL}	Input Current Low Level	$V_{IL} = V_{EE}$			-18	-25	μA
V _{OH}	Output Voltage High Level	I _{OH} = −2 mA	All logic level	2			V
V _{OL}	Output Voltage Low Level	$I_{OL} = +2 \text{ mA}$	outputs			V _{EE} + 0.6	V
V_{SDID}	Serial Input Voltage, Differential		SDI	200		1600	mV _{P-P}
V _{CMI}	Input Common Mode Voltage	V _{SDID} = 200 mV		V _{EE} +1.2		V _{CC} -0.2	V

(1) Current flow into device pins is defined as positive. Current flow out of device pins is defined as negative. All voltages are referenced to V_{EE} (equal to zero volts).

(2) Typical values are stated for: V_{CC} = +3.3V, T_A = +25°C.



SNLS253A-MARCH 2008-REVISED OCTOBER 2009

DC ELECTRICAL CHARACTERISTICS (continued)

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified. (1)(2)

Symbol	Parameter	Conditions	Reference	Min	Тур	Max	Units
V_{SDOD}	Serial Output Voltage, Differential	100Ω differential load	SDO, SCO	720	800	880	mV _{P-P}
V _{CMO}	Output Common Mode Voltage	100Ω differential load			V _{CC} - V _{SDOD}		V
I _{CC}	Power Supply Current, 3.3V supply, Total	270 Mbps			100		mA

AC ELECTRICAL CHARACTERISTICS

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified. ⁽¹⁾

Symbol	Parameter	Conditions	Reference	Min	Тур	Max	Units
BR _{SD}	Serial Data Rate	SMPTE 259M-C	SDI, SDO		270		Mbps
TOL _{JIT}	Serial Input Jitter Tolerance	270 Mbps, (2) (3) (4)	SDI	>6			UI _{P-P}
TOL _{JIT}	Serial Input Jitter Tolerance	270 Mbps, ^{(2) (3) (5)}		>0.6			UI _{P-P}
t _{JIT}	Serial Data Output Jitter	270 Mbps, ⁽³⁾ ⁽⁶⁾	SDO		0.02	0.08	UI _{P-P}
BW_{LOOP}	Loop Bandwidth 270 Mbps, <0.1dB Peaking				300		kHz
F _{CO} Serial Clock Output Frequency		270 Mbps data rate	SCO		270		MHz
t _{JIT}	Serial Clock Output Jitter				2	3	ps _{RMS}
	Serial Clock Output Alignment with respect to Data Interval		SDO, SCO	40		60	%
	Serial Clock Output Duty Cycle		SCO	45		55	%
T _{ACQ}	Acquisition Time					⁽⁷⁾⁽⁸⁾ 15	ms
t _r , t _f	Input rise/fall time	10%–90%	Logic inputs		1.5	3	ns
t _r , t _f	Input rise/fall time	20%-80%	SDI			1500	ps
t _r , t _f	Output rise/fall time	10%–90%	Logic outputs		1.5	3	ns
t _r , t _f	Output rise/fall time	20%-80%, ⁽⁹⁾	SDO, SCO		90	130	ps
F_{REF}					27		MHz
F _{TOL}	Reference Clock Frequency Tolerance				±50		ppm

(1)

Typical values are stated for: V_{CC} = +3.3V, T_A = +25°C. Peak-to-peak amplitude with sinusoidal modulation per SMPTE RP 184-1996 paragraph 4.1. The test data signal shall be color bars. (2)

This parameter is ensured by characterization over voltage and temperature limits. Refer to "A1" in Figure 1 of SMPTE RP 184-1996. Refer to "A2" in Figure 1 of SMPTE RP 184-1996. (3)

(4)

(5)

Serial Data Output Jitter is total output jitter with 0.2 UI_{P-P} input jitter. (6)

(7) Specification is ensured by design.

Measured from first SDI transition until Lock Detect (LD) output goes high (true). (8)

(9) $R_L = 100\Omega$ differential.



www.ti.com

DEVICE DESCRIPTION

The LMH0026 SD SDI Reclocker is used in many types of digital video signal processing equipment. The LMH0026 supports the SMPTE 259M (C) serial digital video standard, with a corresponding serial data rate of 270 Mbps. DVB-ASI data at 270 Mbps may also be retimed. The LMH0026 retimes the serial data stream to suppress accumulated jitter. It provides two low-jitter, differential, serial data outputs. The second output may be selected to output either serial data or a low-jitter serial data-rate clock. Controls and indicators are: serial data-rate clock or second serial data output select, SD indicator output, lock detect output, auto/manual data bypass, and output mute.

Serial data inputs are CML and LVPECL compatible. Serial data and data-rate clock outputs are differential CML and produce LVPECL compatible levels. The output buffer design can drive AC or DC-coupled, terminated 100 Ω differential loads. The differential output level is 800 mV_{P-P} ±10% into 100 Ω AC or DC-coupled differential loads. Logic inputs and outputs are LVCMOS compatible.

The device package is an HTSSOP-20 with an exposed die attach pad. The exposed die attach pad is electrically connected to device ground (V_{EE}) and is the negative electrical terminal for the device. This terminal must be connected to the negative power supply or circuit ground.

Serial Data Inputs, Serial Data and Clock Outputs

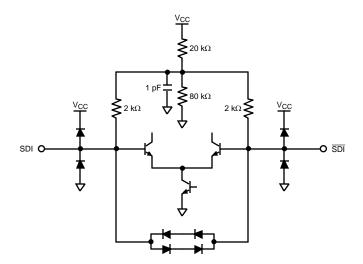
SERIAL DATA INPUT AND OUTPUTS

The differential serial data input, SDI, accepts 270 Mbps serial digital video data. The serial data input is differential LVPECL compatible. The input is intended to be DC interfaced to devices such as the LMH0074 adaptive cable equalizer. The input is not internally terminated or biased. The input may be AC-coupled if a suitable input bias voltage is provided. Figure 2 shows the equivalent input circuit for SDI and SDI.

The LMH0026 has two, retimed, differential, serial data outputs, SDO and SCO/SDO2. These outputs provide low jitter, differential, retimed data to devices such as the LMH0001 or LMH0002 cable driver. Output SCO/SDO2 is multiplexed and can provide either a second serial data output or a serial data-rate clock output. Figure 3 shows the equivalent output circuit for SDO, SDO, SCO/SDO2, and SCO/SDO2.

The SCO_EN input controls the operating mode for the SCO/SDO2 output. When the SCO_EN input is high the SCO/SDO2 output provides a serial data-rate clock. When SCO_EN is low, the SCO/SDO2 output provides retimed serial data.

Both differential serial data outputs, SDO and SCO/SDO2, are muted when the OUTPUT $\overline{\text{MUTE}}$ input is a logic low level. SCO/SDO2 also mutes when the Bypass mode is activated when this output is operating as the serial clock output. When muted, SDO and $\overline{\text{SDO}}$ (or SDO2 and $\overline{\text{SDO2}}$) will assume opposite differential output levels. The CML serial data outputs are differential LVPECL compatible. These outputs have internal 50 Ω pull-ups and are suitable for driving AC or DC-coupled, 100 Ω center-tapped, AC grounded or 100 Ω un-center-tapped, differentially terminated networks.







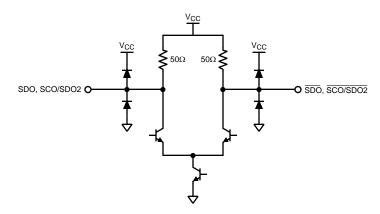


Figure 3. Equivalent SDO Output Circuit (SDO, SDO, SCO/SDO2, SCO/SDO2)

SERIAL DATA CLOCK/SERIAL DATA 2 OUTPUT

The Serial Data Clock/Serial Data 2 Output is controlled by the SCO_EN input and provides either a second retimed serial data output or a low jitter differential clock output appropriate to the serial data rate being processed. When operating as a serial clock output, the rising edge of the clock will be positioned within the corresponding serial data bit interval within 10% of the center of the data interval.

Differential output SCO/SDO2 functions as the second serial data output when the SCO_EN input is a logic-low level. This output functions as the serial data-rate clock output when the SCO_EN input is a logic-high level. The SCO_EN input has an internal pull-down device and the default state of SCO_EN is low (serial data output 2 enabled). SCO/SDO2 is muted when the OUTPUT MUTE input is a logic low level. When the Bypass mode is activated and this output is functioning as a serial clock output, the output will also be muted. If an unsupported data rate is used while in Auto Bypass mode with this output functioning as a serial clock output, the output is invalid.

Control Inputs and Indicator Outputs

LOCK DETECT

The Lock Detect (LD) output, when high, indicates that data is being received and the PLL is locked. LD may be connected to the OUTPUT MUTE input to mute the data and clock outputs when no data signal is being received. Note that when the Bypass/Auto Bypass input is set high, Lock Detect will remain low. See Table 1.

OUTPUT MUTE

The OUTPUT MUTE input, when low, mutes the serial data and clock outputs. It may be connected to Lock Detect or externally driven to mute or un-mute the outputs. If OUTPUT MUTE is connected to LD, then the data and clock outputs are muted when the PLL is not locked. This function overrides the Bypass function: see Table 1. OUTPUT MUTE has an internal pull-up device to enable the output by default.

BYPASS/AUTO BYPASS

The Bypass/Auto Bypass input, when high, forces the device to output the data without reclocking it. When this input is low, the device automatically bypasses the reclocking function when the device is in an unlocked condition or the detected data rate is a rate which the device does not support. Note that when the Bypass/Auto Bypass input is set high, Lock Detect will remain low. See Table 1. BYPASS/AUTO BYPASS has an internal pull-down device.

INSTRUMENTS

www.ti.com

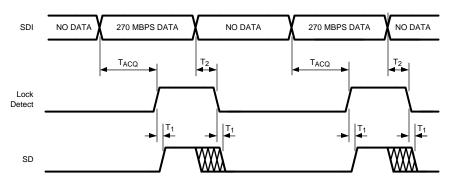
FXAS

LOCK DETECT	OUTPUT MUTE	BYPASS/AUTO BYPASS	DEVICE STATUS
0	1	Х	PLL unlocked, reclocker bypassed
1	1	0	PLL locked to supported data rate, reclocker not bypassed
Х	0	Х	Outputs muted
0	LOCK DETECT	Х	Outputs muted
1	LOCK DETECT	0	PLL locked to supported data rate, reclocker not bypassed

Table 1. Control Functionality

SD

The SD output indicates that the LMH0026 is locked and processing SD data rates. It may be used to control another device such as the LMH0002 cable driver. When this output is high it indicates that the data rate is 270 Mbps. The SD output is a registered function and is only valid when the PLL is locked and the Lock Detect output is high. When the PLL is not locked (the Lock Detect output is low), the SD output defaults to low. The SD output is undefined for a short time after lock detect assertion or de-assertion due to a data change on SDI. See Figure 4 for a timing diagram showing the relationship between SDI, Lock Detect, and SD.



 $T_{\mbox{ACQ}}$ = Acquisition Time, defined in the AC Electrical Characteristics Table

 T_1 = Time from Lock Detect assertion or deassertion until SD output is valid, typically 37 ns (one 27 MHz clock period) T_2 = Time from SDI input change until Lock Detect de-assertion, 1 ms maximum. SD output is not valid during this time.

Figure 4. SDI, Lock Detect, and SD Timing

SCO_EN

Input SCO_EN enables the SCO/SDO2 differential output to function either as a serial data-rate clock or second serial data output. SCO/SDO2 functions as a serial data-rate clock when SCO_EN is high. This pin has an internal pull-down device. The default state (low) enables the SCO/SDO2 output as a second serial data output.

CRYSTAL OR EXTERNAL CLOCK REFERENCE

The LMH0026 uses a 27 MHz crystal or external clock signal as a timing reference input. A 27 MHz parallel resonant crystal and load network may be connected to the XTAL IN/EXT CLK and XTAL OUT pins. Alternatively, a 27 MHz LVCMOS compatible clock signal may be input to XTAL IN/EXT CLK. Parameters for a suitable crystal are given in Table 2.

8 Submit Documentation Feedback



www.ti.com

Table 2. Crystal Parameters

Parameter	Value
Frequency	27 MHz
Frequency Stability	±50 ppm @ recommended drive level
Operating Mode	Fundamental mode, Parallel Resonant
Load Capacitance	20 pF
Shunt Capacitance	7 pF
Series Resistance	40Ω max.
Recommended Drive Level	100 µW
Maximum Drive Level	500 µW
Operating Temperature Range	-10°C to +60°C

APPLICATION INFORMATION

Figure 5 shows an application circuit for the LMH0026 along with the LMH0074 SMPTE 259M / 344M Adaptive Cable Equalizer and LMH0001 SMPTE 259M / 344M Cable Driver.

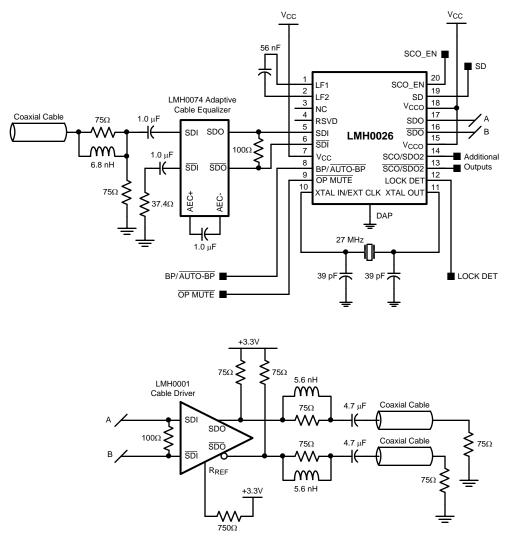


Figure 5. Application Circuit

LMH0026

SNLS253A-MARCH 2008-REVISED OCTOBER 2009



www.ti.com

The LMH0026 inputs are LVPECL compatible. The LMH0026 has a wide input common mode range and in most cases the input should be DC coupled. For DC coupling, the inputs must be kept within the common mode range specified in DC ELECTRICAL CHARACTERISTICS. Figure 5 shows an example of a DC coupled interface between the LMH0074 cable equalizer and the LMH0026. The LMH0074 output common mode voltage and voltage swing are within the range of the input common mode voltage and voltage swing of the LMH0026. All that is required is a 100 Ω differential termination as shown. The resistor should be placed as close to the LMH0026 input as possible. If desired, this network may be terminated with two 50 Ω resisters and a center tap capacitor to ground in place of the single 100 Ω resistor.

The LMH0026 outputs are LVPECL compatible. SDO is the primary data output and SCO/SDO2 is a second output that may be set as the serial clock or a second data output. Both outputs are always active. The LMH0026 output should be DC coupled to the input of the receiving device as long as the common mode ranges of both devices are compatible. Figure 5 shows an example of a DC coupled interface between the LMH0026 and LMH0001 cable driver. All that is required is a 100 Ω differential termination as shown. The resistor should be placed as close to the LMH0001 input as possible. If desired, this network may be terminated with two 50 Ω resisters and a center tap capacitor to ground in place of the single 100 Ω resistor.

The external loop filter capacitor (between LF1 and LF2) should be 56 nF. This is the only supported value; the loop filter capacitor should not be changed.

BYPASS/AUTO BYPASS has an internal pulldown to enable Auto Bypass mode by default. This pin may be pulled high to force the LMH0026 to bypass all data.

OUTPUT MUTE has an internal pullup to enable the outputs by default. This pin may be pulled low to mute the outputs.

The XTAL IN/EXT CLK and XTAL OUT pins are shown with a 27 MHz crystal and the proper loading. The crystal should match the parameters described in Table 2. Alternately, a 27MHz LVCMOS compatible clock signal may be input to XTAL IN/EXT CLK.

The active high LOCK DETECT output provides an indication that proper data is being received and the PLL is locked.

The SD output may be used to drive the SD/HD pin of an SDI cable driver (such as the LMH0002) in order to properly set the cable driver's edge rate for SMPTE compliance. It defaults to low when the LMH0026 is not locked.

SCO_EN has an internal pulldown to set the second output (SCO/SDO2) to output data. This pin may be pulled high to set the second output as a serial clock.

The ground connection for the LMH0026 is through the large exposed DAP. The DAP must be connected to ground for proper operation of the LMH0026.



24-Jan-2013

PACKAGING INFORMATION

Orderable Device	e Stat	s Pac	• • •	•	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
	(1)			Drawing			(2)		(3)		(4)	
LMH0026MH/NOP	B ACTI	/E	HTSSOP	PWP	20	73	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 85	L026	Samples
LMH0026MHX/NOF	PB ACTI	/E ŀ	HTSSOP	PWP	20	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 85	L026	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ Only one of markings shown within the brackets will appear on the physical device.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

www.ti.com

Texas Instruments

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMH0026MHX/NOPB	HTSSOP	PWP	20	2500	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1

TEXAS INSTRUMENTS

www.ti.com

PACKAGE MATERIALS INFORMATION

26-Mar-2013



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMH0026MHX/NOPB	HTSSOP	PWP	20	2500	367.0	367.0	38.0

MECHANICAL DATA

PWP0020A





IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products		Applications			
Audio	www.ti.com/audio	Automotive and Transportation	www.ti.com/automotive		
Amplifiers	amplifier.ti.com	Communications and Telecom	www.ti.com/communications		
Data Converters	dataconverter.ti.com	Computers and Peripherals	www.ti.com/computers		
DLP® Products	www.dlp.com	Consumer Electronics	www.ti.com/consumer-apps		
DSP	dsp.ti.com	Energy and Lighting	www.ti.com/energy		
Clocks and Timers	www.ti.com/clocks	Industrial	www.ti.com/industrial		
Interface	interface.ti.com	Medical	www.ti.com/medical		
Logic	logic.ti.com	Security	www.ti.com/security		
Power Mgmt	power.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense		
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video		
RFID	www.ti-rfid.com				
OMAP Applications Processors	www.ti.com/omap	TI E2E Community	e2e.ti.com		
Wireless Connectivity	www.ti.com/wirelessconnectivity				

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2013, Texas Instruments Incorporated